Specification of Thermoelectric Module TEFC2-22-7-19

Description

The TEFC2-22-7-19 is a multistage module designed for greater temperature differential cooling, good for cooling and heating up to 100 °C applications. It is a 22-7 couples module in size of 10 mm × 10 mm (top)/8 mm × 8 mm (bottom). If higher operation or processing temperature is required, please specify, we can design and manufacture according to your special requirements.

Features

- High Temperature Differential
- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

Application

- Infrared (IR) Sensors
- CCD Sensor
- Gas Analyzers
- Calibration Equipment
- CPU cooler and scientific instrument
- Photonic and medical systems
- Guidance Systems

Performance Specification Sheet

Th (℃)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	97.5	109.5	Temperature Difference between cold and hot side of the module when	
			cooling capacity is zero at cold side	
U _{max} (Voltage)	2.69	2.93	Voltage applied to the module at DT _{max}	
I _{max} (amps)	1.9	1.9	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	1.63	1.74	Cooling capacity at cold side of the module under DT=0°C	
AC resistance (Ohms)	1.23	1.32	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters

10±0.2 8±0.2 50±3 Negative wire (Black) 1x45° Hot Side Postive wire (Red) 1x45° Bot side:Th See ordering option // See ordering option // See ordering option

Manufacturing Options

A. Solder: B. Sealant:

1. T100: BiSn (Tmelt=138°C)

1. NS: No sealing (Standard)

2. T200: CuAgSn (Tmelt = 217°C) 2. SS: Silicone sealant

3. T240: SbSn (Tmelt = 240°C) 3. EPS: Epoxy sealant

C. Ceramics: D. Ceramics Surface Options:

1. Alumina (Al₂O₃, white 96%)

1. Blank ceramics (not metalized)

2. Aluminum Nitride (AlN) 2. Metalized

Ordering Option

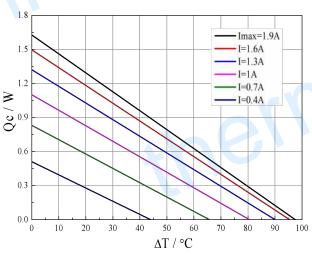
Suffix	Thickness (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	0:4.45±0.1	0.03/0.03	50±3/Specify

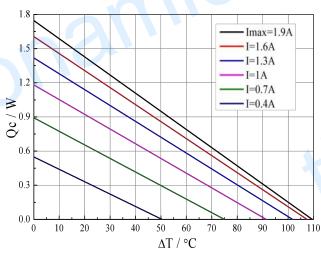
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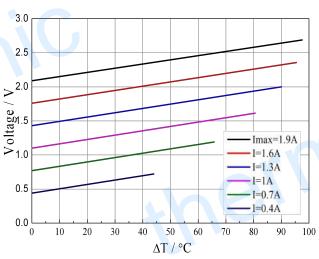
Performance Curves at Th=27 °C

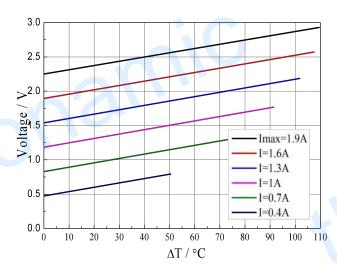
Performance Curves at Th=50 °C



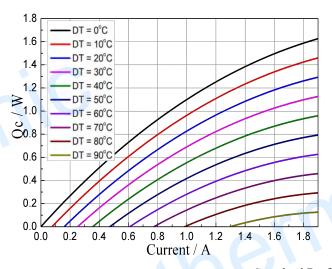


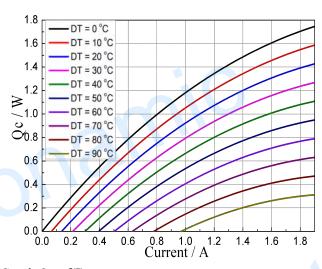
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V = f(DT)



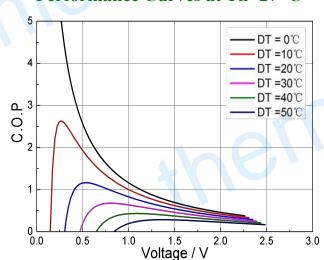


Standard Performance Graph Qc = f(I)

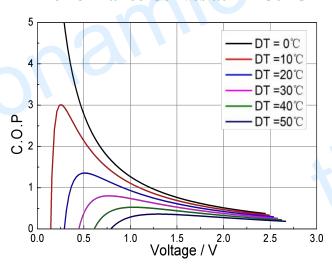
Specification of Thermoelectric Module

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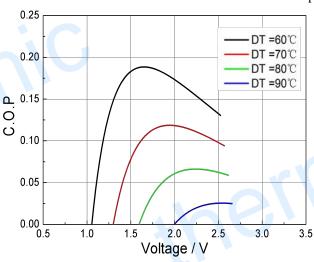
Performance Curves at Th=27 °C

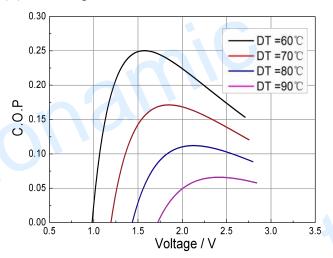


Performance Curves at Th=50 °C



Standard Performance Graph COP = f(V) of DT ranged from 0 to 50 °C





Standard Performance Graph COP = f(V) of DT ranged from 60 to 90/100 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V × I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Storage module below 100 °C
- ullet Operation below I_{max} or V_{max}
- Work under DC